

# Second Call for Papers 2015 IEEE Conference on Electron Devices and Solid-State Circuits (EDSSC'2015)

June 1-4, 2015, Singapore http://www.edssc2015.org

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Kong-Pang PUN Chinese University of Hong Kong, Hong Kong, China **EDSSC'2015** is the 11th in a series of very successful conferences initiated by IEEE ED/SSC Hong Kong Joint Chapter. It provides an international forum for the presentation and discussion of recent advances in Electron Devices and Solid-State Circuits. After its great success at Chengdu, China, in 2014, EDSSC'2015 will be held in Singapore from June 1 through June 4, 2015. The EDSSC'2015 is a four-day program and will include keynote and invited speeches, oral and poster sessions, as well as tutorials. The EDSSC'2015 organizing committees cordially invite your participation and attendance.

Topics of Interest are listed, but not limited to, below:

- Photonics
- RF & Microwave Devices and Circuits
- Power Electronics
- Sensor and MEMS
- Memories
- Organic Devices
- Bio-medical Electronics
- Sustainable Energy
- Nanoelectronics/Spintronics
- Advanced Interconnects and Packaging
- Device and Circuit Reliability
- Communication Circuits
- Digital and Memory Circuits
- Novel Analog Circuits
- Data Processing Circuits

## **Conference Dates and Venue**

<u>Tutorial</u>: June 1, 2015, <u>Conference</u>: June 2-4, 2015 (Keynotes on June 2) Nanyang Executive Center (NEC), 50 Nanyang Avenue, Singapore 639798 <u>http://www.ntu.edu.sg/nec/Pages/default.aspx</u>

## **Important Dates**

Submission Deadline: January 31, 2015 Acceptance Notification: March 31, 2015 Early Registration: April 30, 2015

## **Online Abstract Submission**

Only electronic submission in PDF format will be acceptable. The materials in the abstract must be original and unpublished. Manuscripts should be formatted according to the IEEE conference proceeding standard, using A4 paper size. Please consider using the template files provided by IEEE from the following link and limit the length of the paper to 2 pages. http://www.ieee.org/conferences\_events/conferences/publishing/templates.ht

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## **Further Information**

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